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(12) **United States Design Patent** (10) **Patent No.:** **US D964,968 S**
Liu (45) **Date of Patent:** **** Sep. 27, 2022**

(54) **EARPHONE**
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(**) Term: **15 Years**
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(52) **U.S. Cl.**
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381/379
CPC H04R 1/10; H04R 25/00; H04R 25/02;
H04R 1/1066; H04R 1/1016; H04R
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H04R 1/02; H04R 1/105; H04R 1/1091
See application file for complete search history.

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Primary Examiner — Paula Allen Greene

(57) **CLAIM**

The ornamental design for an earphone, as shown and described.

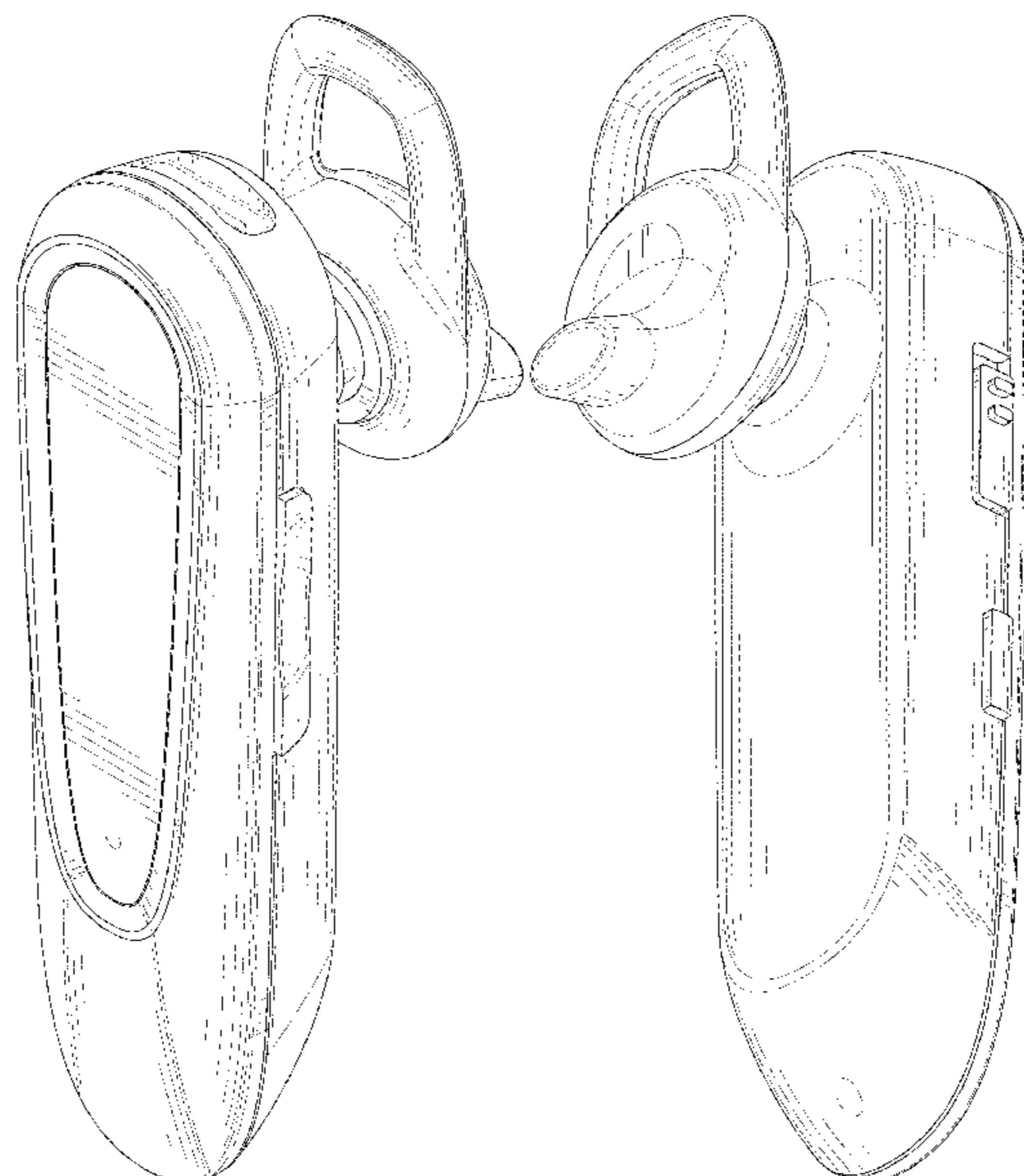
DESCRIPTION

FIG. 1 is a front and top perspective view of an earphone, showing my new design;
FIG. 2 is a rear and bottom perspective view thereof;
FIG. 3 is a front elevation view thereof;
FIG. 4 is a rear elevation view thereof;
FIG. 5 is a left side elevation view thereof;
FIG. 6 is a right side elevation view thereof;
FIG. 7 is a top plan view thereof; and,
FIG. 8 is a bottom plan view thereof.
The broken lines in the figures illustrate portions of the earphone that form no part of the claimed design.

1 Claim, 8 Drawing Sheets

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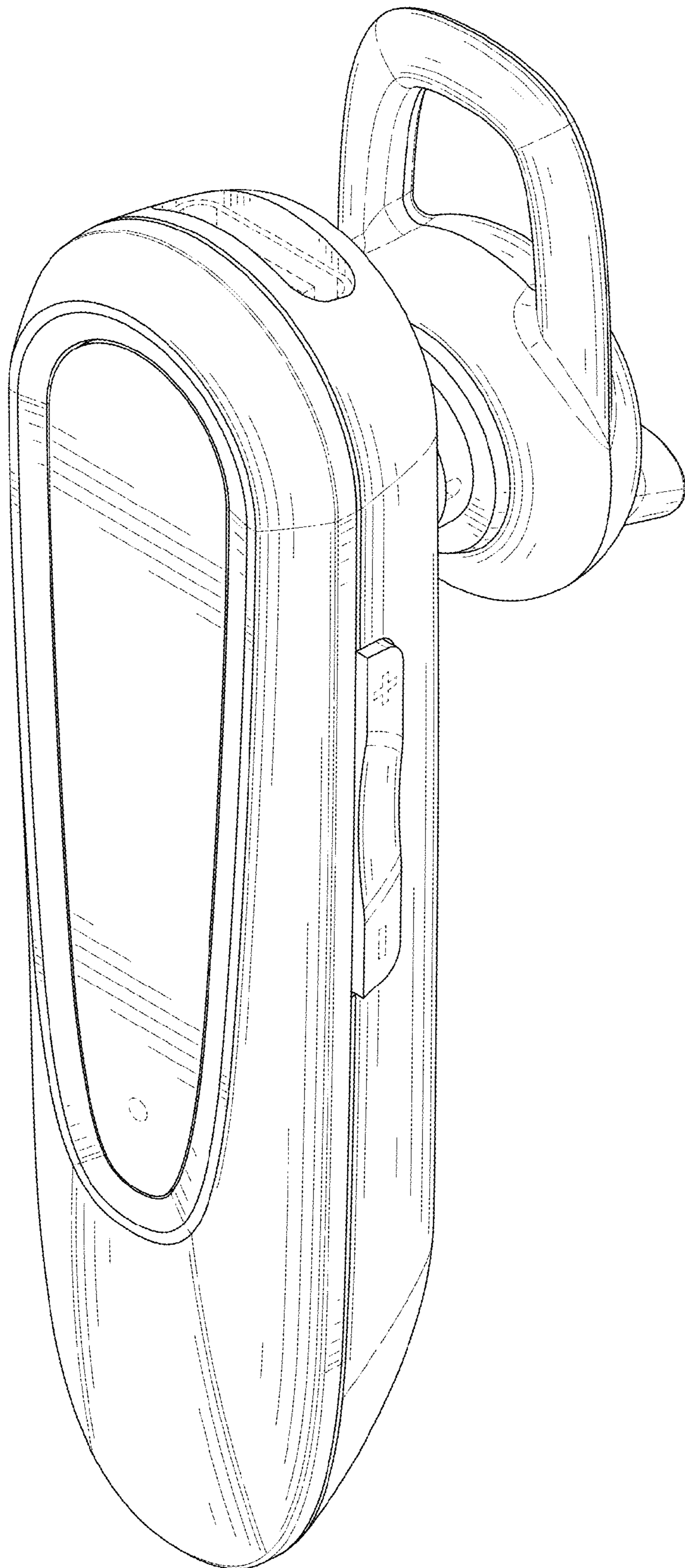


FIG. 1

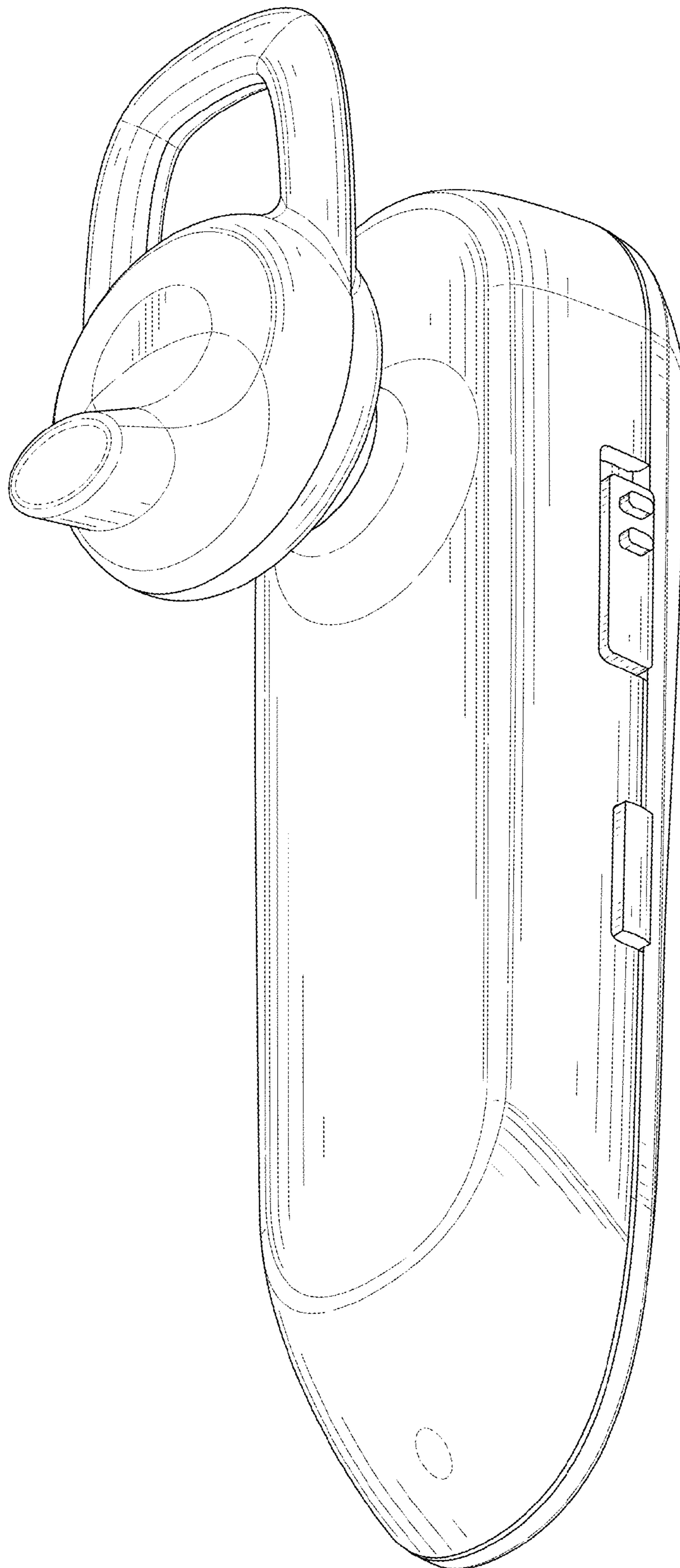


FIG. 2

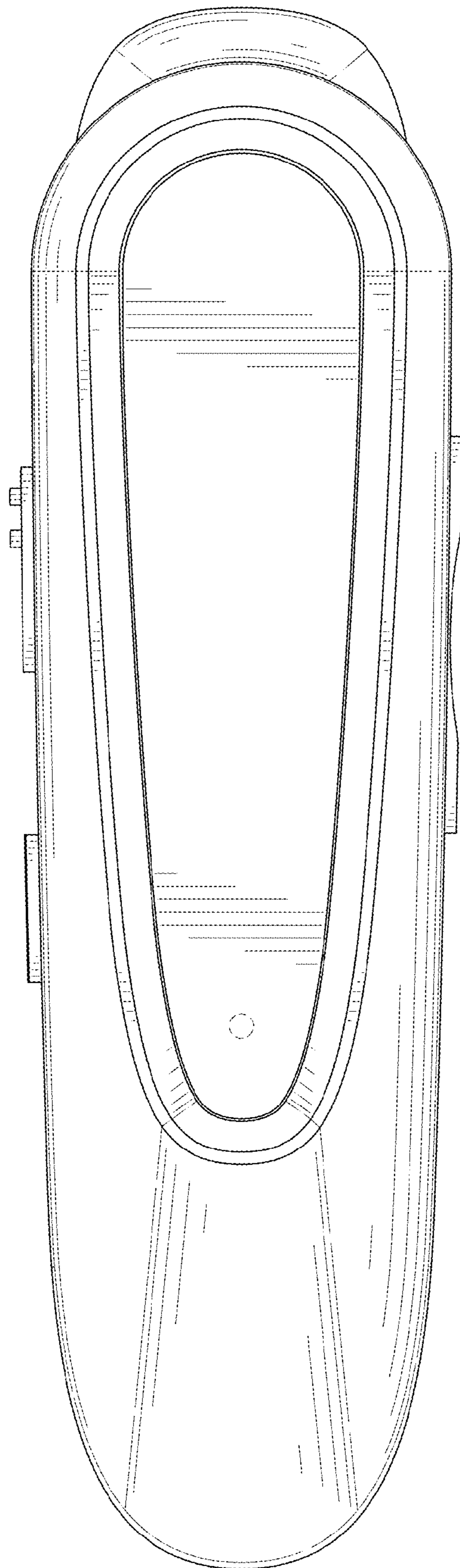


FIG. 3

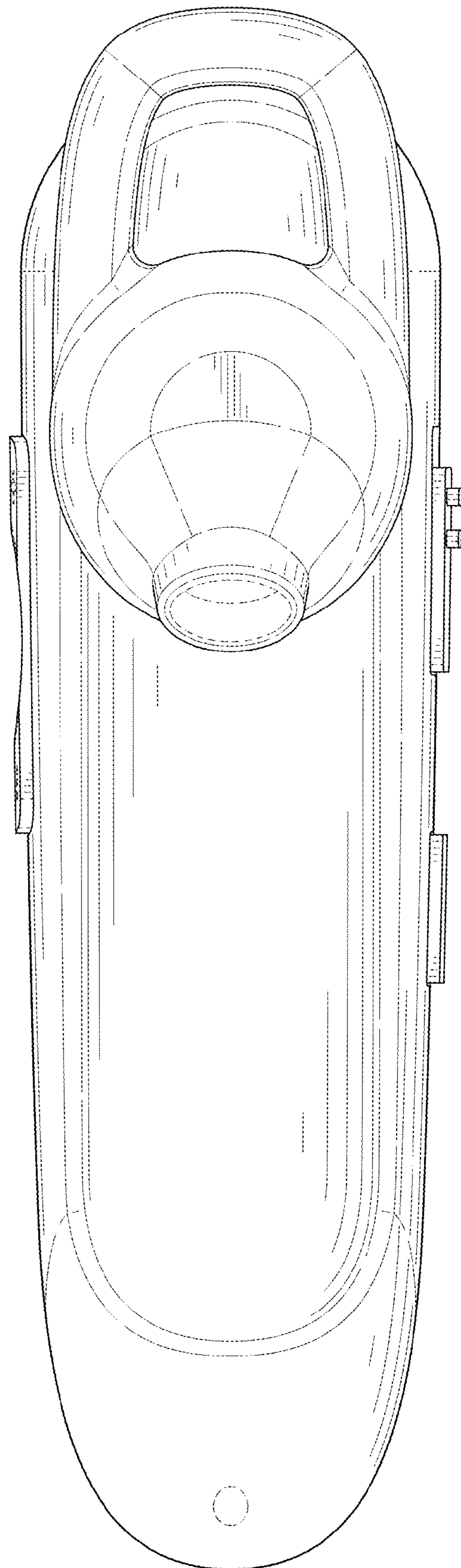


FIG. 4

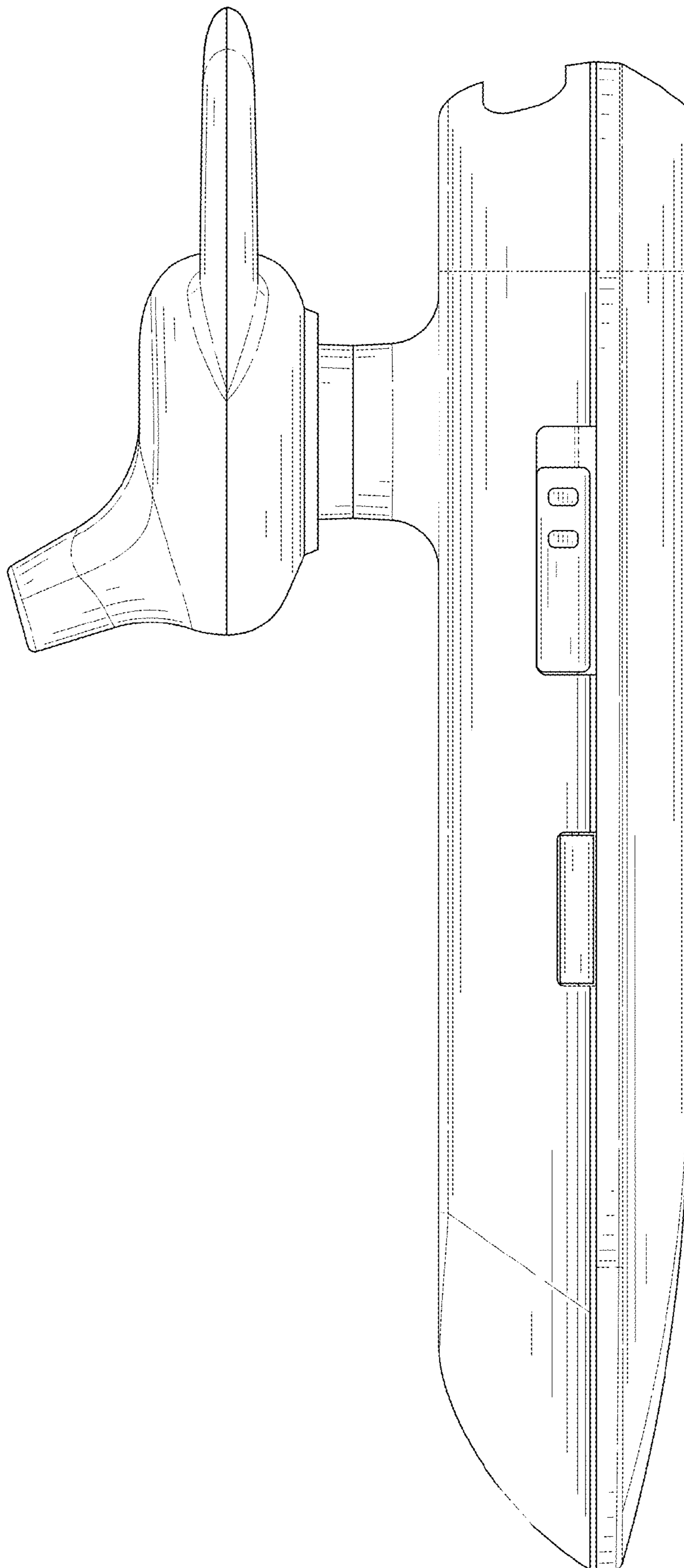


FIG. 5

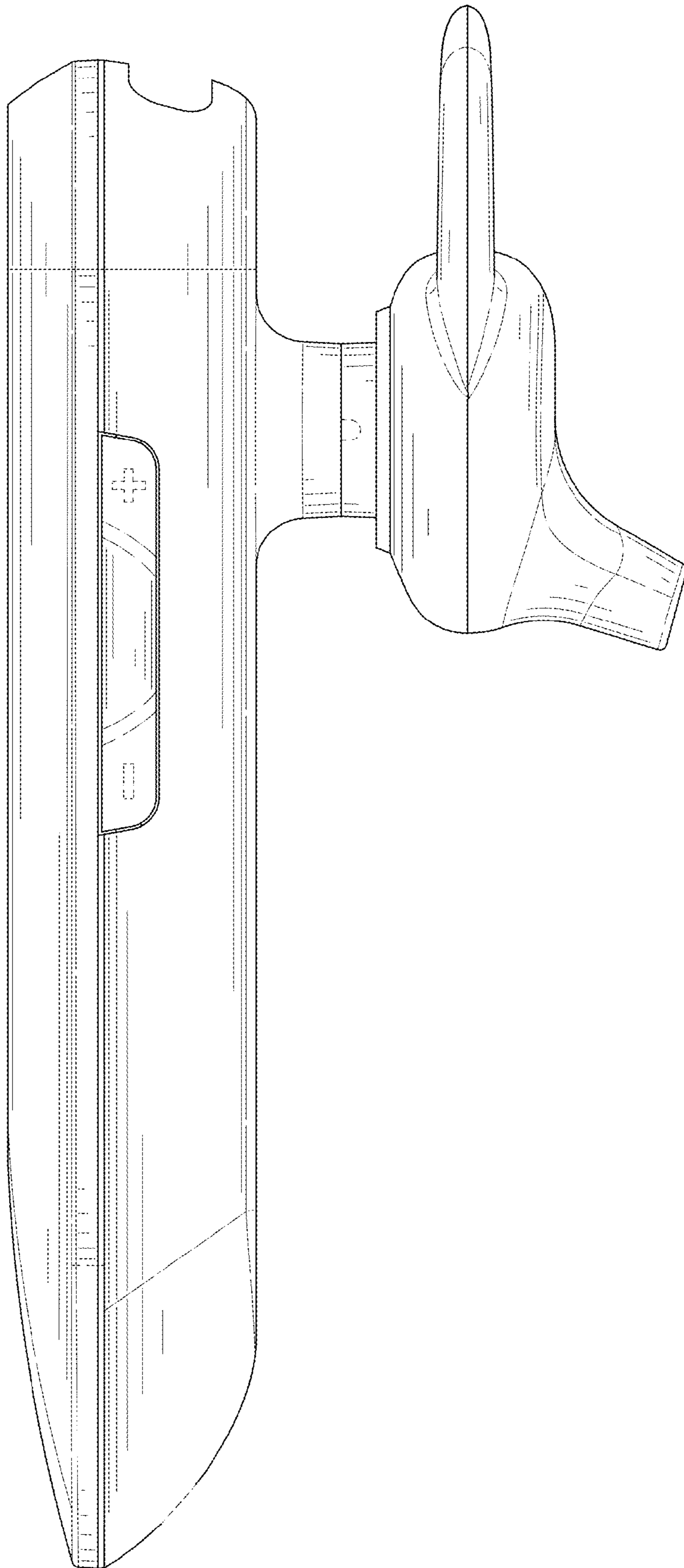


FIG. 6

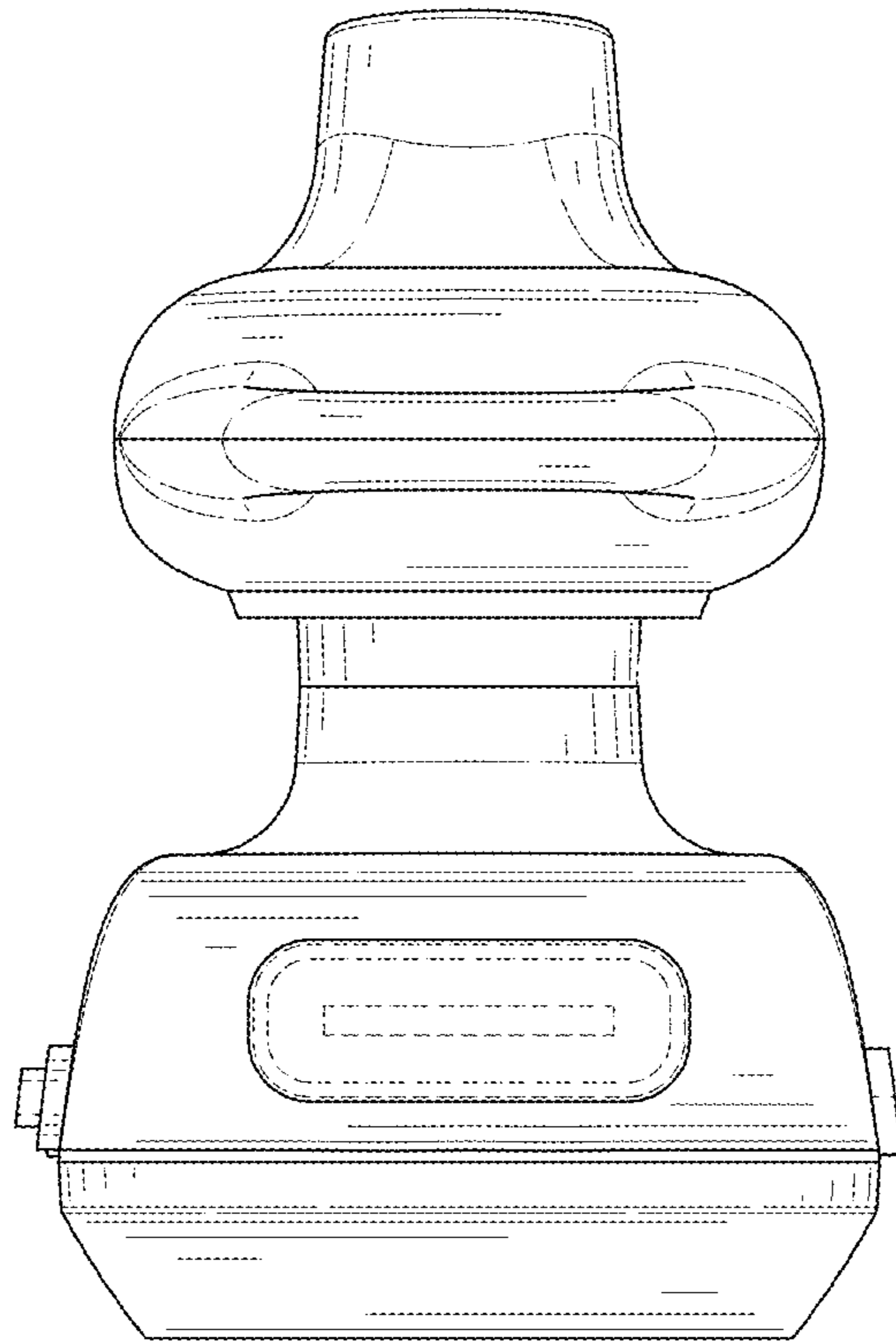


FIG. 7

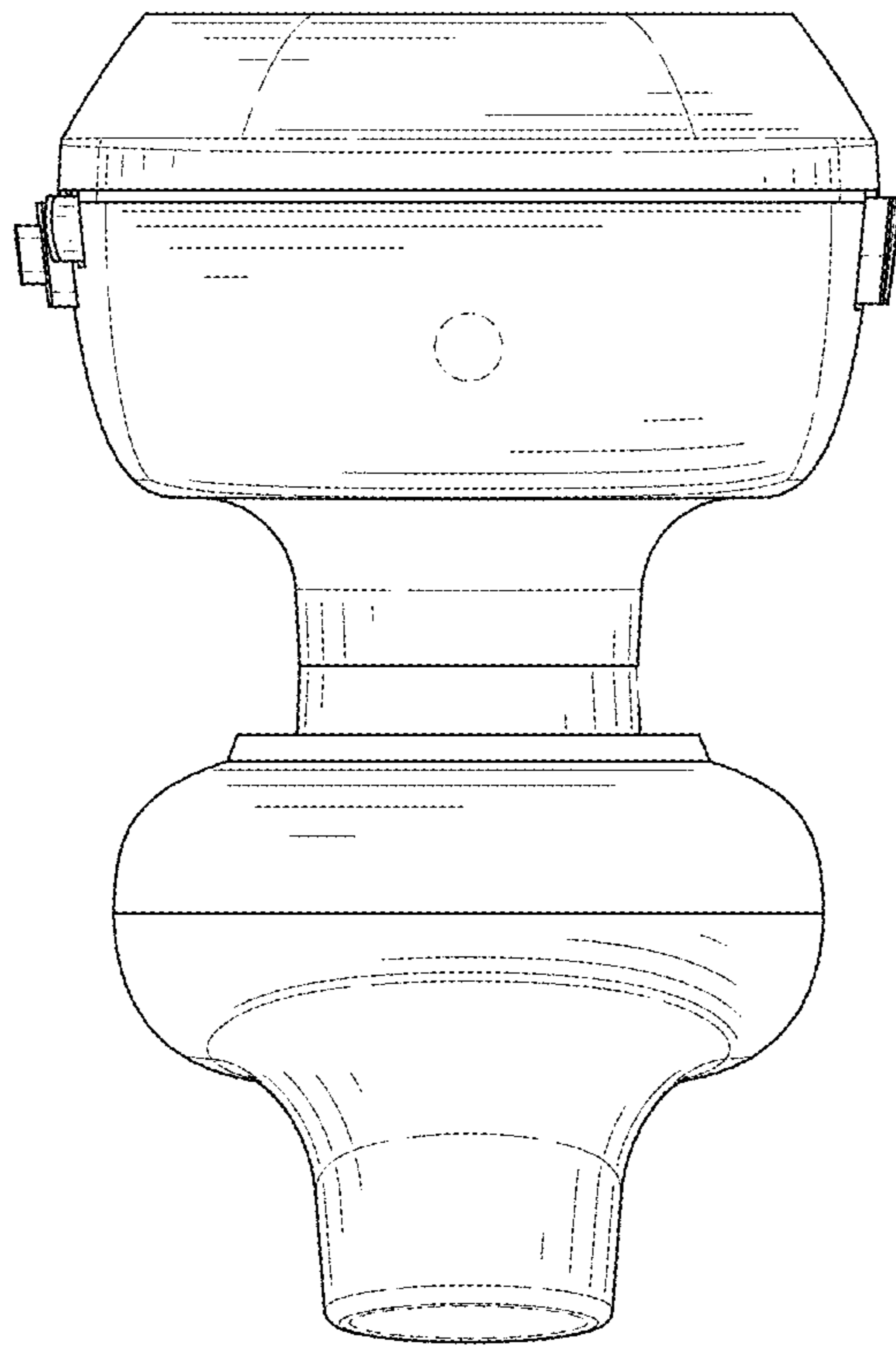


FIG. 8